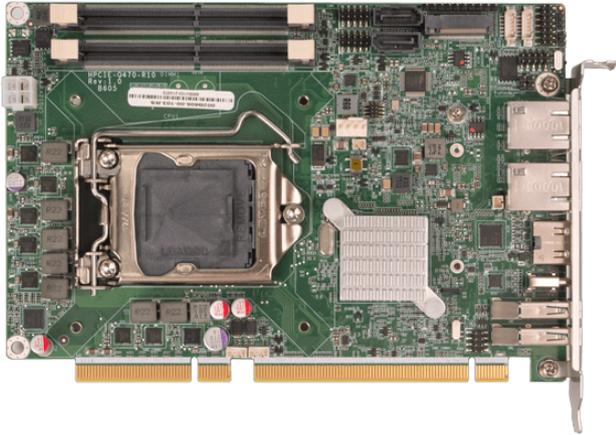


HPCIE-Q470

Half-size PICMG 1.3 CPU Card supports LGA1200 Intel® 10th/11th Gen. Core™ i9/i7/i5/i3, Pentium®, Celeron® CPU with Q470/Q470E, DDR4 SO-DIMM, HDMI™, Dual Intel® 2.5GbE, USB 3.2 Gen2, SATA 6Gb/s, M.2, IAUDIO, and RoHs



Features

1. LGA1200 Intel® 10th/11th Generation Core™ i9/i7/i5/i3, Celeron® and Pentium® processor
2. Dual-channel DDR4 2933MHz
3. Support Dual Intel® 2.5GbE
4. Support M.2 A key for WLAN expansion, M key for PCIe NVMe storage

Specifications

Form Factor	
Form Factor	Half Size Single Board Computer
System	
CPU	LGA1200 Intel® 10th/11th Gen. Core™ i9/i7/i5/i3, Pentium® and Celeron® processor (Support up to 65w)
Chipset	Intel® Q470/Q470E
Memory	2 x 260-pin 2933 MHz Dual-channel DDR4 SO-DIMM, support up to 64G
Memory Max.	up to 64GB
Cooling method / System Fan	1 x CPU fan connector (1x4 pin)
Physical Characteristics	
Dimensions (LxWxH) (mm)	185 mm x 126 mm
Net Weight	420g
Storage	
Storage	2 x SATA : 6Gb/s (support RAID 0/1) 1 x M.2 (NGFF) : M Key (2242/2280) with PCIe Gen3 x4, support NVME storage
I/O Interface	
Display Output	1 x HDMI™ : up to 4096 x 2160@30Hz
Ethernet	2 x LAN : LAN1: Intel® I225V 2.5GbE controller LAN2: Intel® I225V 2.5GbE controller
Audio	1 x HD Audio : 1 x IAUDIO, support IEI AC-KIT-888S Audio Module (2 x 5 pin)
I/O Interface	2 x Internal RS-232/422/485 : 2x5 pin, P=2.00, RS-485 support AFC 2 x External USB 3.2 Gen1x1 : 5Gb/s (Type-A) 2 x Internal USB 2.0 : 2x4 pin, P=2.00 DIO : 12-bit digital I/O (2x7 pin) 1 x External USB 3.2 Gen2x1 : 10Gb/s (Type-C)
Expansion	1 x PCIe x16 : signal from CPU via golden finger (supports x16, or x8 + x8, or x4 + x4 + x8) 1 x PCIe x4 : signal from PCH via golden finger (supports x4, or x1 + x1 + x1 + x1)

	2 x M.2(NGFF) : 1 x M.2 A key (2230) with PCIe Gen3 x2/USB 2.0 1 x M.2 M key (2280/2242) with PCIe Gen3 x4
Power	
Power Supply	5V/12V, ATX/AT power supply
	Support AT/ATX mode
	ErP/EuP Compliant
Environment	
Operating Temperature	0°C – 60°C
Storage Temperature	-30°C – 70°C
Humidity	5% ~ 95%, non-condensing
Certifications	
Safety & EMC	CE/FCC compliant

Ordering Information

HPCIE-Q470-R10	Half-size PICMG 1.3 CPU Card supports LGA1200 Intel® 10th Gen. Core™ i9/i7/i5/i3/Pentium®/Celeron® CPU with Q470E, DDR4 SO-DIMM, HDMI™, USB-C, Dual Intel® 2.5GbE, USB 3.2, SATA 6Gb/s, M.2, HD Audio, iAMT and RoHs
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Packing List

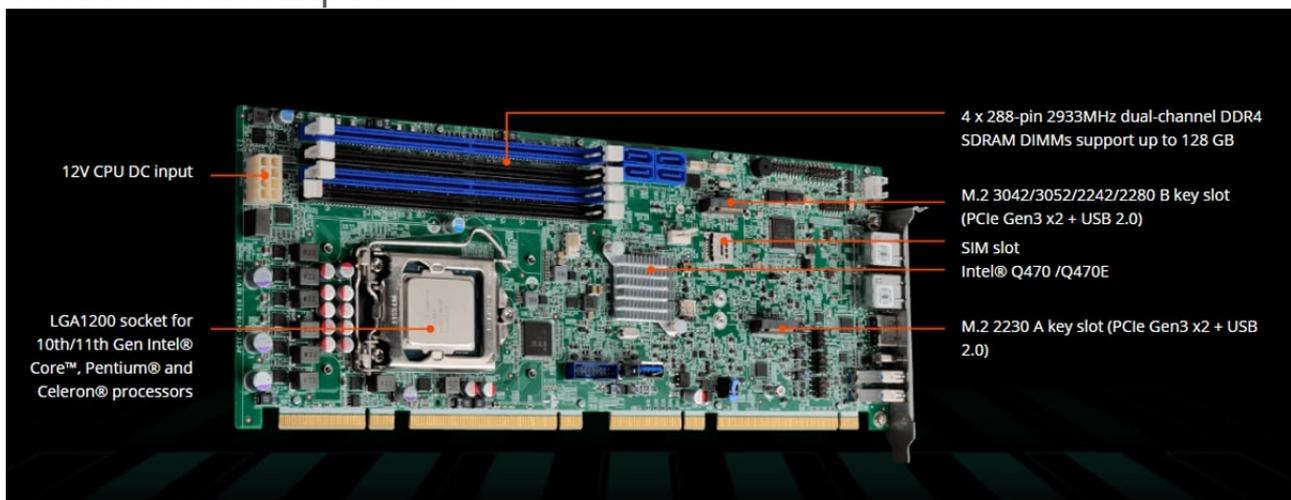
1 x HPCIE-Q470 single board computer	2 x SATA cable
1 x I/O shielding	1 x QIG

Maximizes Design Flexibility

The PCIE-Q470 is a full-size PICMG® 1.3 single board computer with scalable CPU options of 10th/11th Intel® Generation Core™ i9/i7/i5/i3, Pentium® and Celeron® processors and Intel® Q470/Q470E chipset, supporting up to 10 cores. With IEI's comprehensive passive backplane and industrial chassis options, the configurable system can offer increased computing efficiency and flexible I/O expandability through PCIe x16, PCIe x4 and legacy PCI signals, allowing more industrial add-on cards to satisfy the requirements of performance-demanding applications in medical radiology equipment, digital surveillance, transportation and automation applications.

Spec Overview

Performance and Expansion



Connectivity



Solder Side



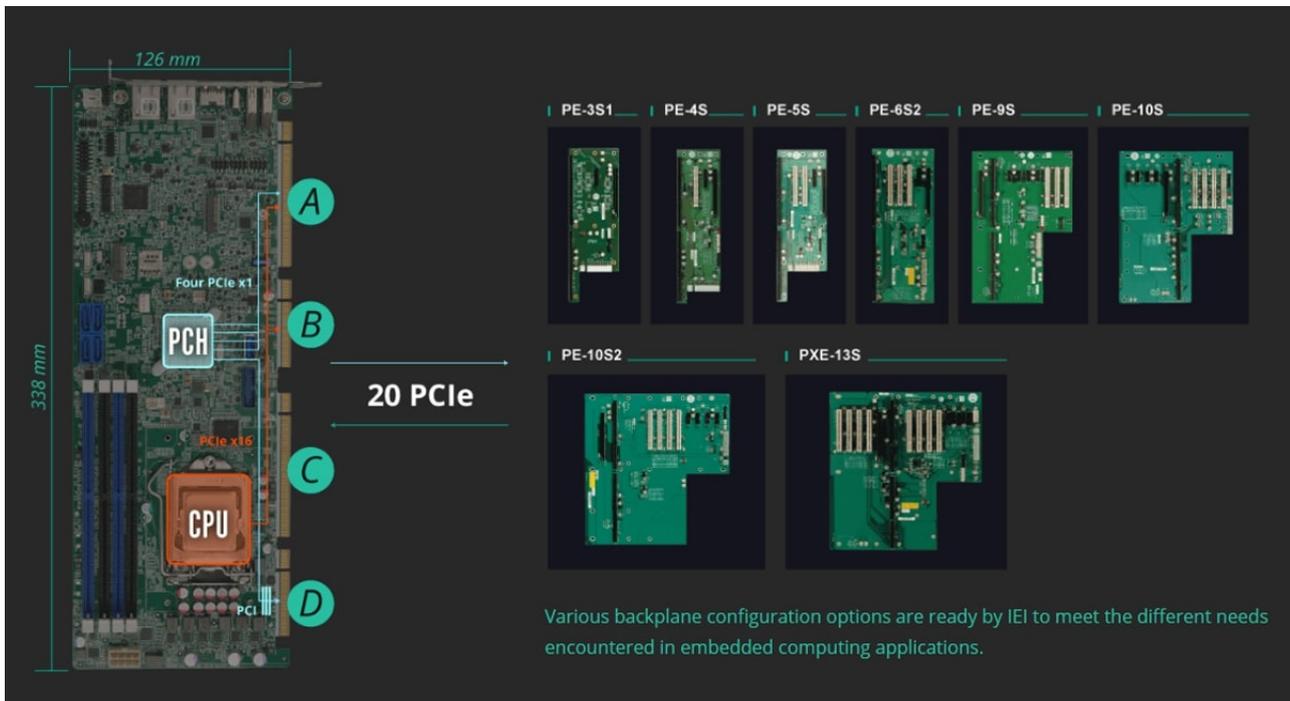
Full-size PICMG 1.3



Standard PICMG 1.3 SBCs have several advantages over non-standard SBCs. Firstly, they are more maintainable than a motherboard system and have a much lower mean time to repair (MTTR). Secondly, it is easy to upgrade to a newer or faster processor if desired.

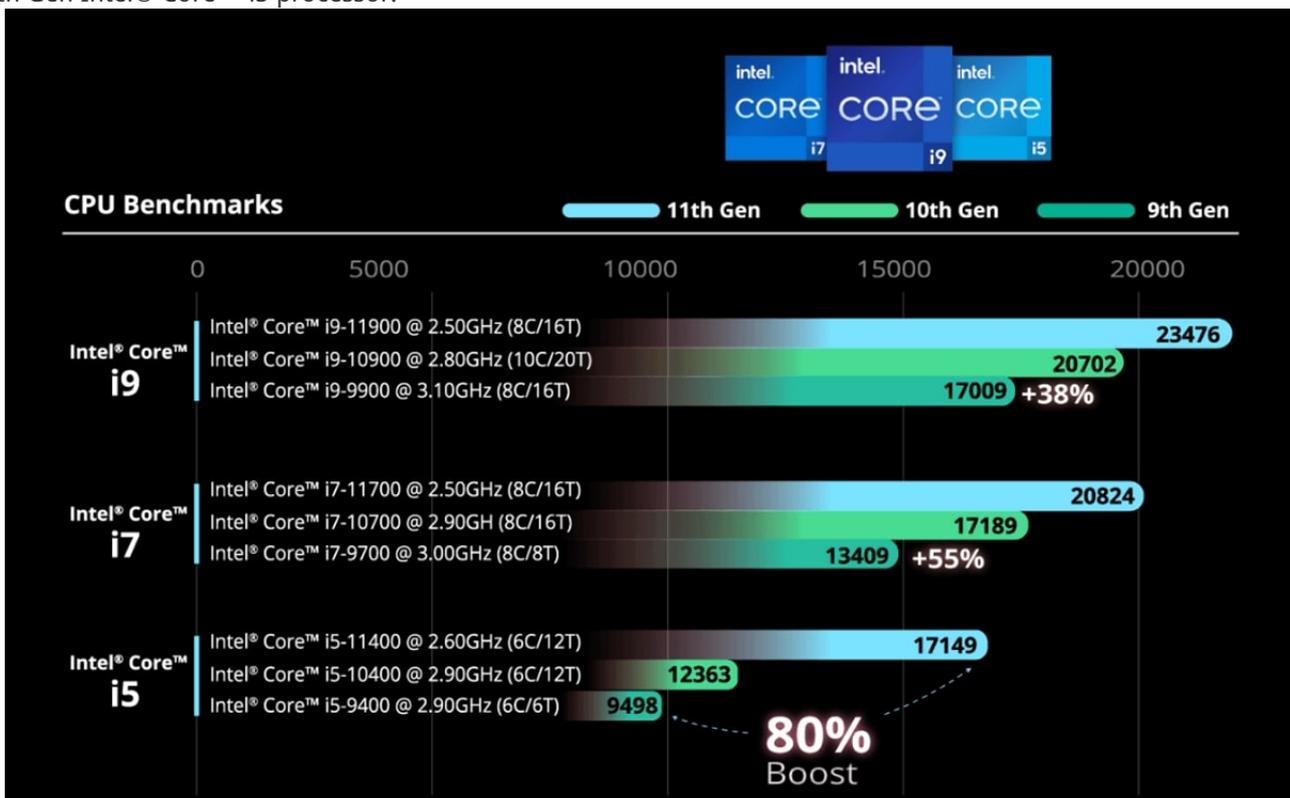
Features of PICMG 1.3:

- *20 PCI Express: 20 PCI Express lanes are supported, including PCI Express x16, x8, x4 and x1 configurations
- *ATX power signals are supported: Provides AUX voltages for standby power and sleep states (soft starts, wake on LAN), supports PSON#, PWRGD, PWRRBT# and ACPI states



Performance Boost

The 10th and 11th Gen Intel® Core™ processors, ranging from 6 to 10 cores, with increased I/O capacity and the latest DDR4-2933 memory support deliver the performance required to consolidate multiple industrial workloads. The CPU benchmark boosts up to 85% better integer multi-tasking compute intensive application performance on 11th Gen Intel® Core™ i5 processor.

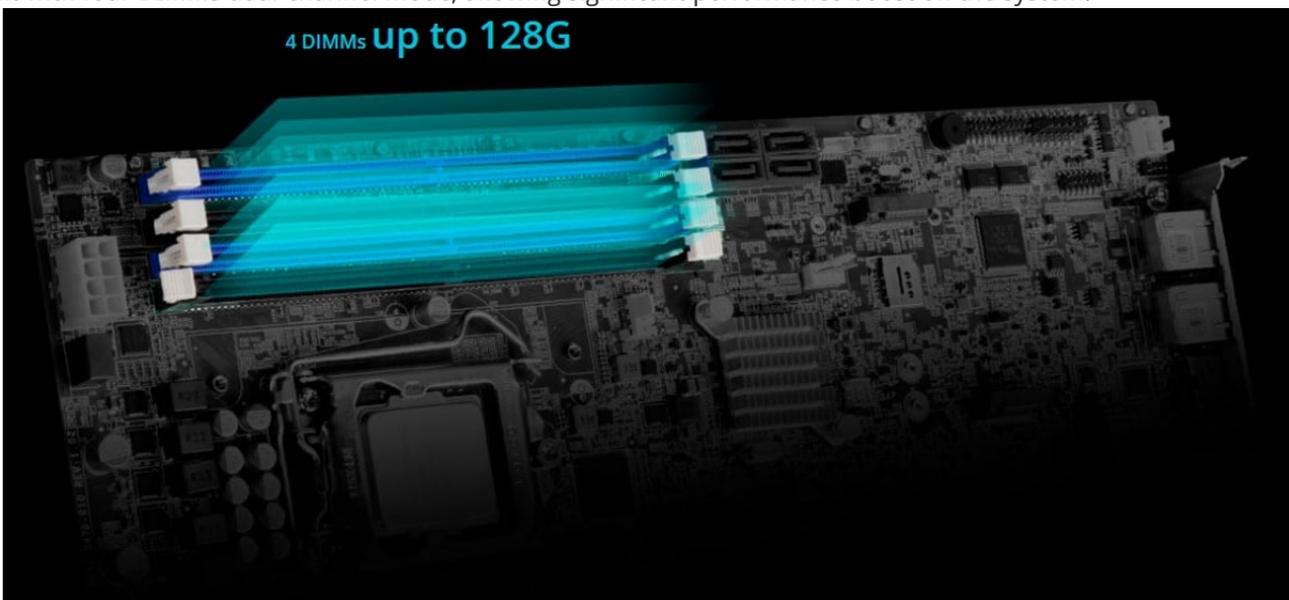


Embedded CPU Support List for 10th Gen Intel® Processors

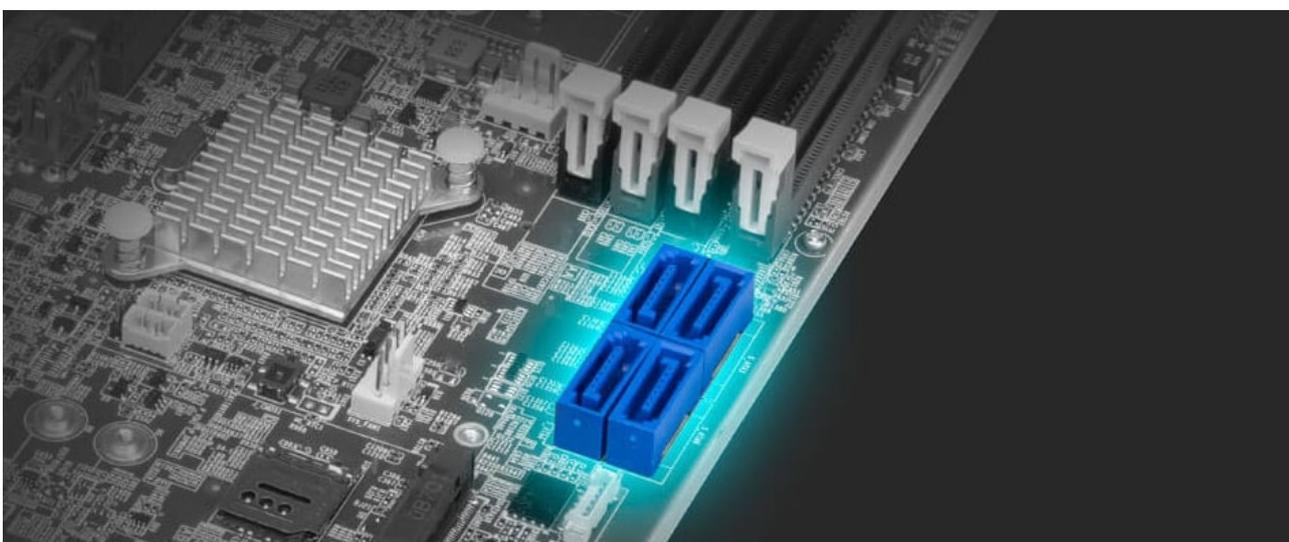
Sockets	Brand	Process	Cores/Threads	CPU	Processor Base Frequency	Cache	TDP	Processor Graphics	Graphics Base Frequency	Memory Types	Chipset
FCLGA1200	Core™ i9	14nm Comet Lake-S	10/20	I9-10900E	2.8 GHz	20MB	65W	Intel® UHD Graphics 630	350 MHz	DDR4-2933	Q470/Q470E
			10/20	I9-10900TE	1.8 GHz	20MB	35W			DDR4-2933	
	Core™ i7		8/16	I7-10700E	2.9 GHz	16MB	65W			DDR4-2933	
			8/16	I7-10700TE	2.0 GHz	16MB	35W			DDR4-2933	
	Core™ i5		6/12	I5-10500E	3.1 GHz	8MB	65W			DDR4-2666	
			6/12	I5-10500TE	2.3 GHz	8MB	35W			DDR4-2666	
	Core™ i3		4/8	I3-10100E	3.2 GHz	9MB	65W			DDR4-2666	
	Core™ i3		4/8	I3-10100TE	2.3 GHz	9MB	35W			DDR4-2666	
	Pentium®		2/4	G6400E	3.8 GHz	4MB	58W			DDR4-2400	
	Pentium®		2/4	G6400TE	3.2 GHz	4MB	35W			DDR4-2400	
	Celeron®		2/2	G5900E	3.2 GHz	2MB	58W			DDR4-2400	
	Celeron®		2/2	G5900TE	3.0 GHz	2MB	35W			DDR4-2400	

Performance Boost DDR4 Dual-channel

Built with four DIMMs dual-channel mode, allowing significant performance boost on the system.



Data Protection



RAID 0/1/5/10 Protection

The PCIE-Q470 offers four high speed SATA 6Gb/s interfaces with configurable RAID 0, 1, 5, 10 functionality that can expand storage capabilities and enable fast data transfers.



- RAID 0 (Striping) -The highest performing level
- RAID 1 (Mirroring) -Data safety
- RAID 5 (Distributed Parity)-offers both data safety and performance
- RAID 10 (combining mirroring and striping) data safety and big data volume



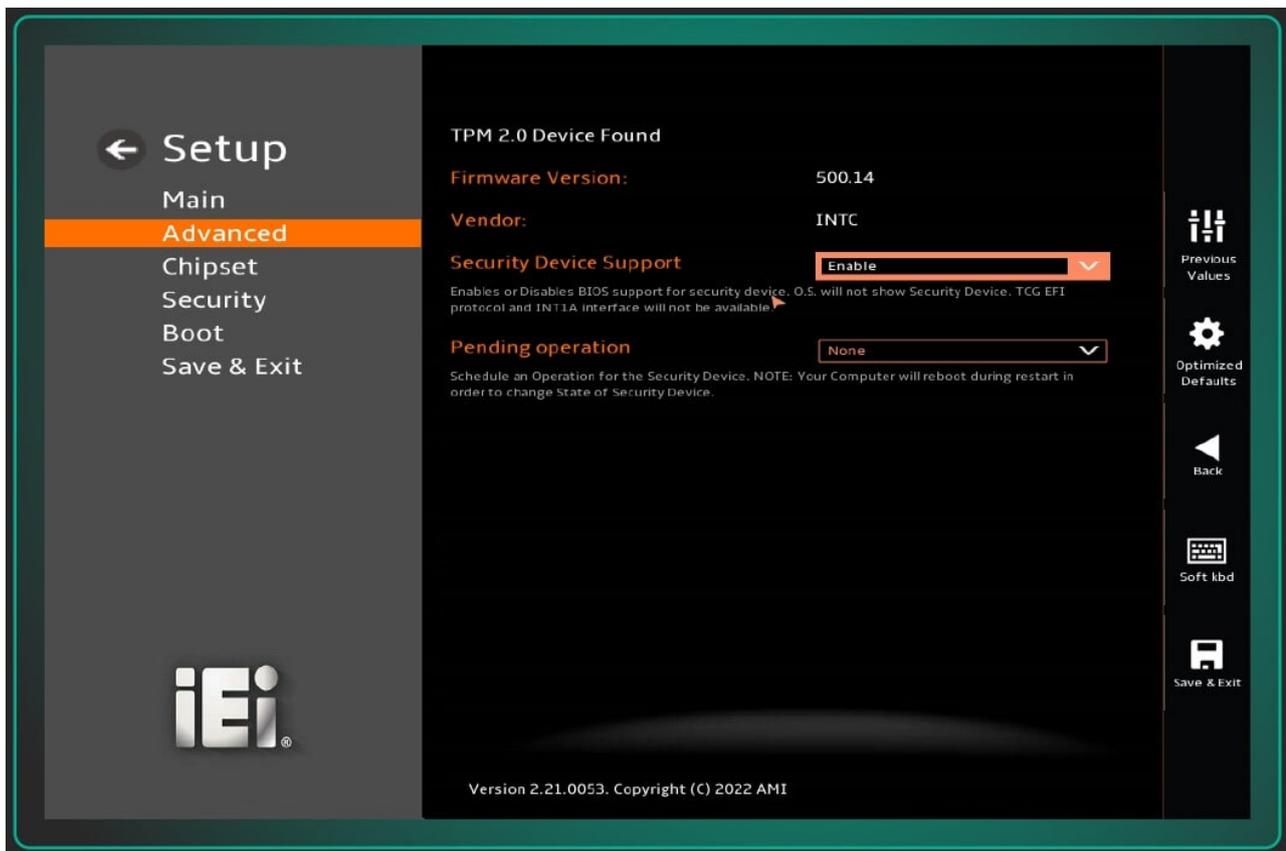
Features	RAID 0	RAID 1	RAID 5	RAID 10
Minimum # Drives	2	2	3	4
Data Protection	No	Single-drive failure	Single-drive failure	Up to one disk failure in each sub-array
Capacity Utilization	100%	50%	67%-94%	50%
Typical Application	High end workstations, data logging, real-time rendering, very transitory data	Operating system, Transaction database	Data warehousing, web serving, archiving	Fast databases, application servers

Internal USB Encryption Lock

The internal 180° USB port allows users to plug-in a USB encryption lock directly onto the motherboard so the device is hidden away and safely contained within the case of the system. With data encrypted, you don't need to worry about leaking private data any more.

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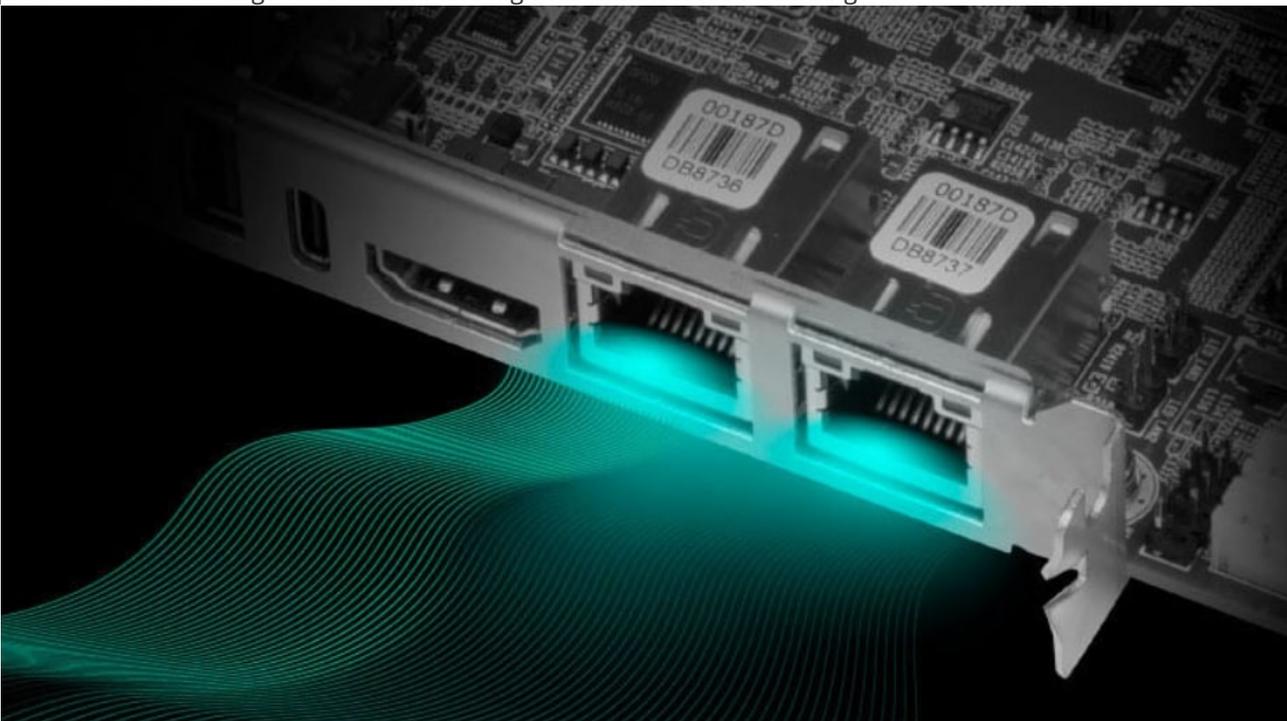
TPM 2.0 Security



High Speed Transmission

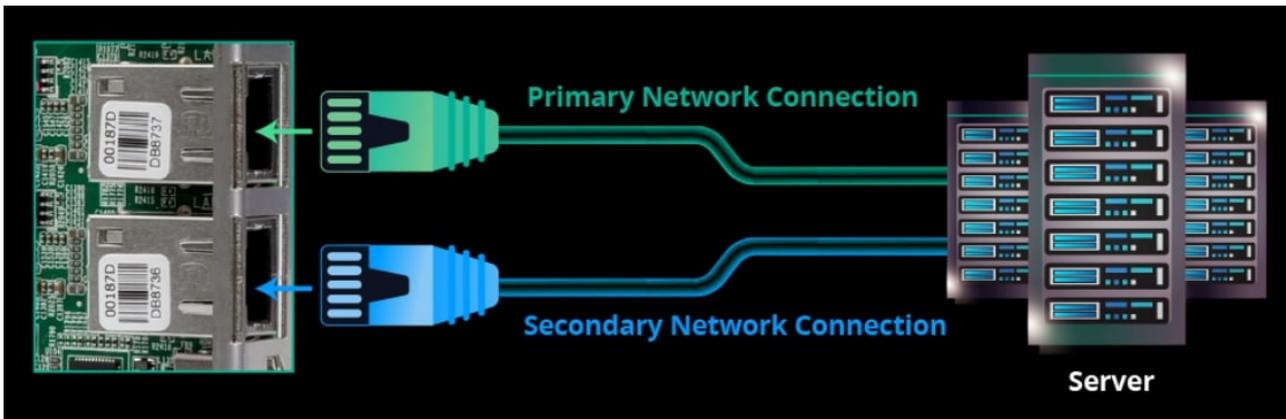
Delivers Dual Low-Latency 2.5G LAN by Intel

The on-board dual Intel® I225V 2.5GbE controllers enable the PCIe-Q470 to meet the bandwidth-intensive requirements such as large file transfers and high-resolution video streaming.



Redundant Networking Connection

With dual LAN configuration, the network redundancy for an internet connection has backup connectivity to switch the network from the first LAN input to the other LAN input automatically to avoid and mitigate the risk of downtime.



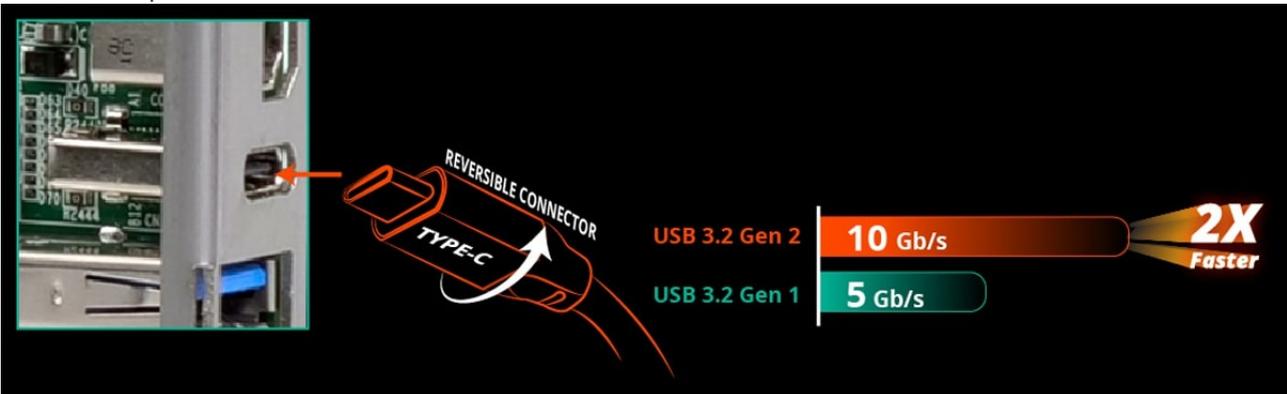
Multiple Device Connection

With dual LAN configuration, the single-board computer is capable of connecting various devices such as sensors, multiple cameras, or other hardware that connects to an industrial SBC.



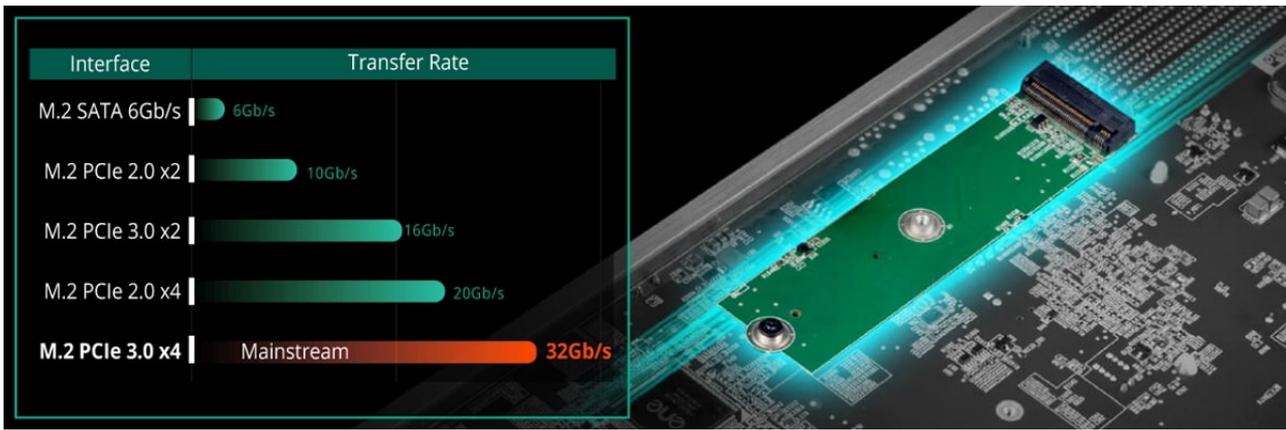
10 Gb/s USB 3.2 Gen 2 Type-C Foolproof Connector

USB Type-C connectors are widely adopted by many electronic devices, such as portable SSD hard drives, smart phones, USB cameras, etc. The PCIE-Q470 uses the reversible connector that should end the bane of users fiddling at the back of computers.



M.2 2242/2280 M Key for NVMe SSD or AI Accelerator

The M.2 2242/80 M-key socket with PCI Express® 3.0 x4 bandwidth supports up to 32Gbps data-transfer speeds. The sequential read/write speed is 5 times than SATA 6Gb/s. It's the perfect choice for installing an operating system or application drive to provide fast data access.



AI Accelerator

The Mustang-M2BM-MX2 card equipped with two Intel® Movidius™ Myriad™ X VPU, providing an flexible AI inference computing.

[Learn More](#)

NVMe

Networking

M.2 B Key with SIM Slot for LTE Cellular Communication

The M.2 B key supporting PCI Express 3.0 x2 signals plus onboard SIM slot allows you to use a LTE radio frequency to ensure secure and delay-free data transmission in smart manufacturing.

Wi-Fi 6E

- 2.4 GHz
- 5 GHz
- 6 GHz

M.2 B Key

- 3042
- 3052

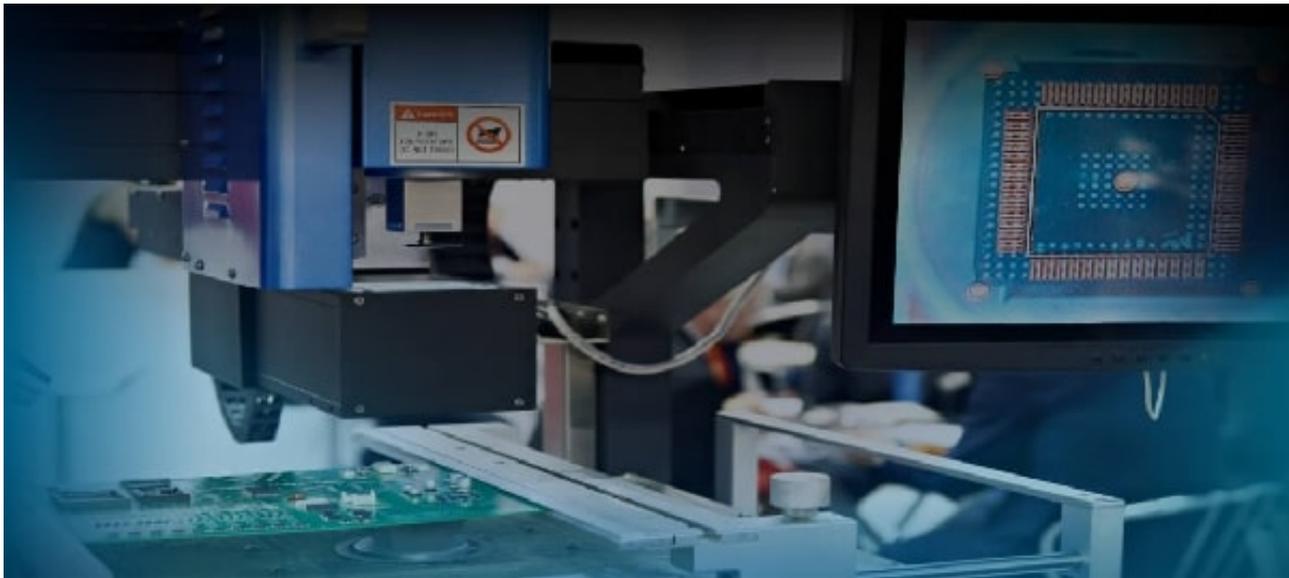
M.2 A Key

M.2 2230 A Key for Wi-Fi/Bluetooth

The M.2 2230 A key slot carrying with PCIe 3.0 x2 and USB 2.0 signals allows it to adopt the latest Wi-Fi 6E technology. Wi-Fi 6E enhances low latency and supports service levels that are equivalent to 5G networks.

Instant System-level Solution

To suit different AIoT applications, IEI offers a comprehensive range of PICMG 1.3 passive backplanes and industrial chassis to give system designers expanded options for integrating multi-level processors within a variety of configurations.



PAC series wall-mount chassis
 4U/5U rack-mount chassis
 1U/2U rack-mount chassis

PICMG 1.3 (PCIe+PCI)		Model	PE-2SD1	PE-3S1	PE-4S	PE-5S	PE-5S2	PE-6S	PE-6S2	PE-6SD	PE-6SD3
Total Slot			2	5	4	5	5	6	6	5	5
Expansion Slots	PCIe Slots	x16*	1 (Gen 2.0)	1 (Gen 3.0)	1	1 (Gen 2.0)	1 (Gen 2.0)	1 (Gen 2.0)	1 (Gen 2.0)	1 (Gen 2.0)	1 (Gen 2.0)
		X4		1 (Gen 3.0)	1	1 (Gen 2.0)			1 (Gen 2.0)		1 (Gen 2.0)
		X1					3 (Gen 2.0)	2 (Gen 2.0)		3 (Gen 2.0)	
	PCI-X Slots										
	PCI Slots			1	2		2	3			2
USB Connectors by Pin Header			4		4	4	4	4	4	4	4
PSU Type			24+4-pin ATX	24+4-pin ATX	24+4-pin ATX	24+4-pin ATX					
Chassis			RACK-1150-PE	RACK-500AI	N/A	N/A	N/A	RACK-305G RACK-360G RACK-3000G PAC-1700G PAC-125 G	PAC-106G PAC-1000G	N/A	N/A
Note			1U Type							2U Type	2U Type

PICMG 1.3 (PCIe+PCI)	Model	PE-7S	PE-8S	PE-9S	PE-10S	PE-10S2	PXE-13S	
Total Slot		7	8	9	10	10	13	
Expansion Slots	PCIe Slots	x16*	1 (Gen 2.0)	1 (Gen 3.0)	1	1 (Gen 2.0)	1 (Gen 2.0)	1 (Gen 3.0)
		X4						
		X1	2 (Gen 2.0)	3 (Gen 2.0)	4 (Gen 2.0)	4 (Gen 2.0)	4 (Gen 2.0)	3 (Gen 3.0)
	PCI-X Slots							
PCI Slots		3	3	3	4	4	8	
USB Connectors by Pin Header		4	4	4	4	4	4	
PSU Type		24+4-pin ATX	24+4-pin ATX	24+4-pin ATX	24+4-pin ATX	24+4-pin ATX	24+4-pin ATX	
Chassis		PAC-1700G	PAC-125G	N/A	RACK-305G RACK-360G RACK-3000G	RACK-3000G RACK-305G RACK-360G	RACK-3000G RACK-305G RACK-360G	
Note							PCIe to PCI Bridge Backplane	

*When using a PCIe x16 add-on card, the length of the card must not exceed 167mm or 6.57 inches.

Automated Inspection Machine Application

